503634951 01/05/2016

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DEENESH PADHI	01/04/2016
YIHONG CHEN	11/20/2015
KELVIN CHAN	11/23/2015
ABHIJIT BASU MALLICK	12/15/2015
ALEXANDROS T. DEMOS	11/20/2015
MUKUND SRINIVASAN	12/17/2015

RECEIVING PARTY DATA

Name:	APPLIED MATERIALS, INC.	
Street Address:	3050 BOWERS AVENUE	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14943913

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	KEITH M. TACKETT
SIGNATURE:	/Keith M. Tackett/
DATE SIGNED:	01/05/2016

PATENT 503634951 REEL: 037411 FRAME: 0618

Total Attachments: 2

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PATENT REEL: 037411 FRAME: 0619

Atty Dkt No.: APPM/22242US

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Deenesh PADHI 776 Shasta Fir Drive Sunnyvale, California 94086	2)	Yihong CHEN 20 Descanso Dr., Unit 1132 San Jose, California 95134
3)	Kelvin CHAN 1740 Blakesley Drive San Ramon, California 94582	4)	Abhijit Basu MALLICK 47863 Masters Court Fremont, California 94539
5)	Alexandros T. DEMOS 39370 Mozart Terrace Fremont, California 94538	6)	Mukund SRINIVASAN 43488 Laurel Glen Common Fremont, California 94539

(hereinafter referred to as Assignors), have invented a certain invention entitled:

ULTRA-THIN DIELECTRIC DIFFUSION BARRIER AND ETCH STOP LAYER FOR ADVANCED INTERCONNECT APPLICATIONS

for which application for Letters Patent in the United States was filed on November 17, 2015, under Serial No. 14/943,913, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, conventional, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority

PATENT REEL: 037411 FRAME: 0620

Atty Dkt No.: APPM/22242US

proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	01/04116 (DATE)	allet or
2)	11/20/2015 (DATE)	Deenesh PADHI Yihong CHEN
3)	11/23/15 (DATE)	Kelvin Chan Kelvin CHAN
4)	12/15/15 (DATE)	Abhijit Basu MALLICK
5)	11 20 15 (DATE)	Mombin Jour Alexandros T. DEMOS
6)	12/17/15 (DATE)	Mukund SRINIVASAN